

Features

- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Ideal for automated placement
- Meets environmental standard MIL-S-19500D
- Solder dip 275 °C, 10s



Package: DO-214AB (SMC)

Applications

For use in general purpose rectification of lighting, power supply, inverter, converter and freewheeling diodes for consumer, automotive and telecommunication.

Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	SL32C	SL33C	SL34C	SL35C	SL36C	SL37C	SL38C	SL39C	SL310C	Unit
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	70	80	90	100	V
Maximum RMS Voltage	V _{RMS}	14	21	28	35	42	49	56	63	70	V
Maximum DC Blocking Voltage	V _{DC}	20	30	40	50	60	70	80	90	100	V
Maximum Average Forward Rectified current at T_L (See Fig.1)	I _{F(AV)}	3								A	
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	I _{FSM}	80								A	
Operating Junction Temperature Range	T _J	- 55 to + 125			- 55 to + 150			°C			
Storage Temperature Range	T _{stg}	- 55 to + 150								°C	

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	SL32C	SL33C	SL34C	SL35C	SL36C	SL37C	SL38C	SL39C	SL310C	Unit
Maximum Instantaneous Forward Voltage	I _F =3 A	V _F	0.42			0.50			0.75			V
Maximum DC Reverse Current at Rated DC Blocking Voltage	TA=25°C	I _R	0.2				0.05				mA	
	TA=100°C		50				4					
Typical Junction Capacitance	4.0 V, 1 MHz	C _J	220								pF	

Thermal Characteristics

Parameter	Symbol	SL32C	SL33C	SL34C	SL35C	SL36C	SL37C	SL38C	SL39C	SL310C	Unit
Maximum Thermal Resistance	R _{θJA} (1)	52				75				°C/W	
	R _{θJT} (2)	17				25					

Notes: (1) Thermal resistance from junction to ambient, 0.315 × 0.315"(8.0 × 8.0mm)copper pads to each terminal

(2) Thermal resistance from junction to terminal, 0.315 × 0.315"(8.0 × 8.0mm)copper pads to each terminal

Ratings and Characteristics Curves

($T_A = 25^\circ\text{C}$ unless otherwise noted)

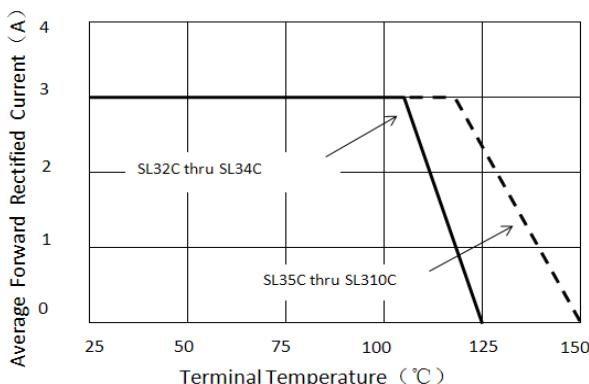


Figure 1. Forward Current Derating Curve

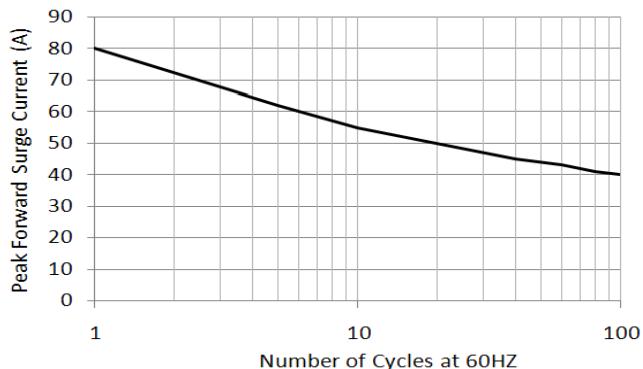


Figure 2. Maximum Non-repetitive Peak Forward Surge Current

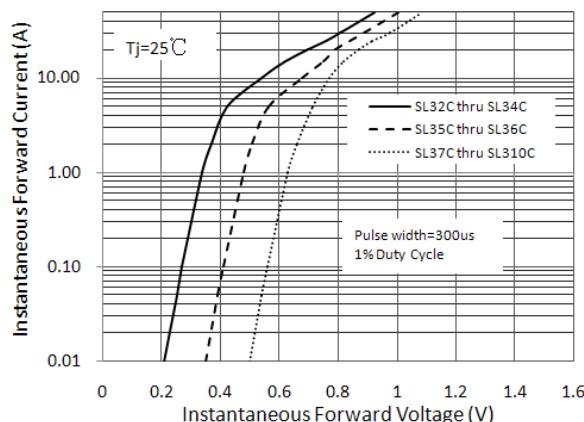


Figure 3. Typical Instantaneous Forward Characteristics

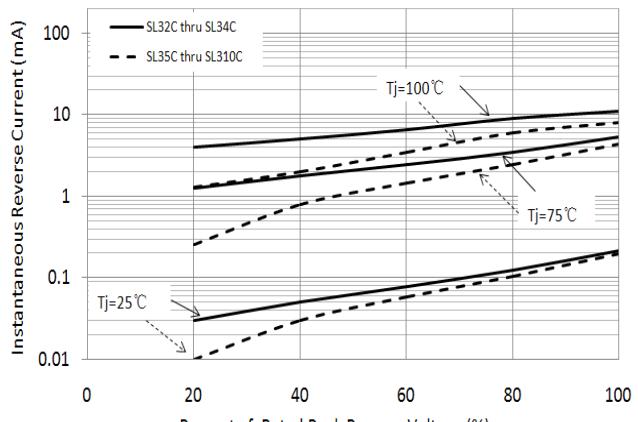


Figure 4. Typical Reverse Characteristics

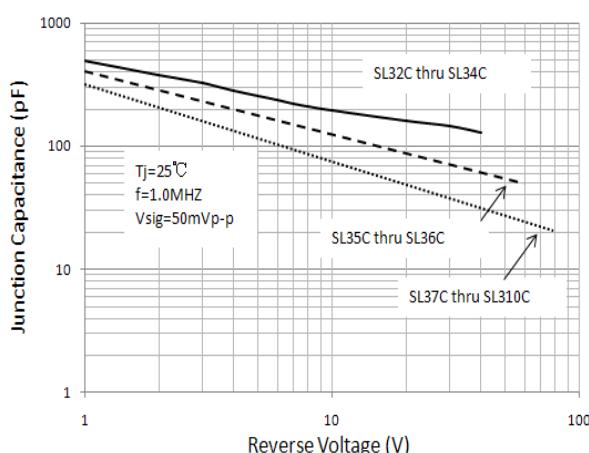
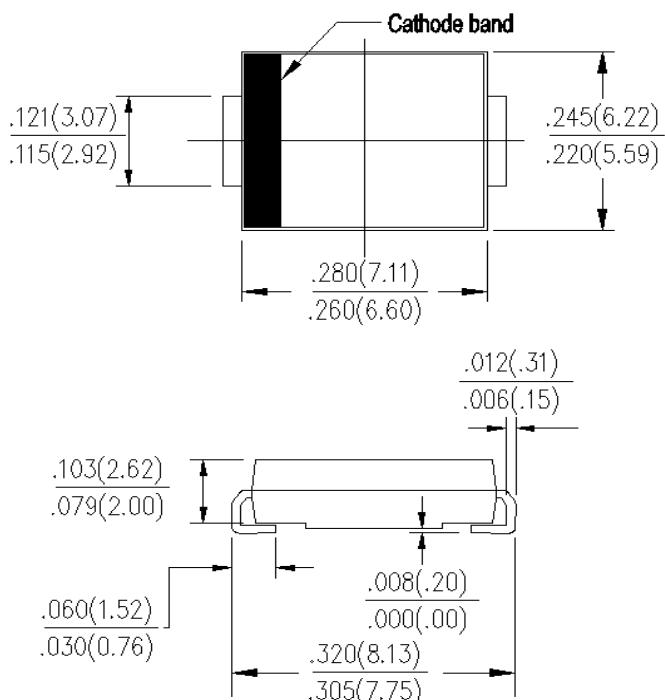


Figure 5. Typical Junction Capacitance

Package Outline Dimensions

in inches (millimeters)

DO-214AB (SMC)



Mounting Pad Layout

